onsemi

Single Non-Inverting Buffer with Open Drain Output

NLV17SZ07

The NLV17SZ07 is a single non-inverting buffer with open drain outputs in tiny footprint packages.

Features

- Designed for 1.65 V to 5.5 V V_{CC} Operation
- 2.1 ns t_{PD} at $V_{CC} = 5 V (typ)$
- Input/Output Overvoltage Tolerant up to 5.5 V
- IOFF Supports Partial Power Down Protection
- Sink 24 mA at 3.0 V
- Available in SC-88A, SOT-553, and SOT-953 Packages
- Chip Complexity < 100 FETs
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

THIS DEVICE PLEASENTATIVE PLEA



SC-88A DF SUFFIX CASE 419A хх м• о •

MARKING DIAGRAMS



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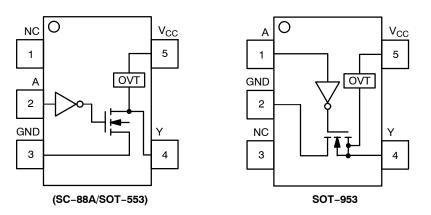
= Specific Device Code = Date Code* = Pb-Free Package

(Note: Microdot may be in either location) *Date Code orientation and/or position may vary depending upon manufacturing location.

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 7 of this data sheet.

NLV17SZ07





PIN ASSIGNMENT (SC-88A/SOT-553)

Pin	Function
1	NC
2	A
3	GND
4	Y
5	V _{CC}

(SC-88A/SOT-553)		PIN ASSIGNMEI	NT (SOT-953)	FUNCTION TABLE
Pin	Function	Pin	Function	Input Output
1	NC	1	A	AY
2	A	2	GND	L
3	GND	3	NC	H Z
4	Y	4	Y	OP i
5	V _{CC}	5	V _{CC}	Forening
THIS	DEVICE PL REF	NOT RECON	NMENOUH ACTYONN	FORMATION

MAXIMUM RATINGS

Symbol	Characteristics	Value	Unit	
V _{CC}	DC Supply Voltage		-0.5 to +7.0	V
V _{IN}	DC Input Voltage		-0.5 to +7.0	V
V _{OUT}		ive-Mode (High or Low State) Tri-State Mode (Note 1) ower-Down Mode (V _{CC} = 0 V)	-0.5 to V _{CC} + 0.5 -0.5 to +7.0 -0.5 to +7.0	V
	DC Output Voltage (NL	17SZ07P5T5G-L22088 Only)	–0.5 to V _{CC} + 0.5	
Ι _{ΙΚ}	DC Input Diode Current	V _{IN} < GND	-50	mA
I _{OK}	DC Output Diode Current	V _{OUT} < GND	-50	mA
	DC Output Diode Current (NL	17SZ07P5T5G-L22088 Only)	±50	
I _{OUT}	DC Output Source/Sink Current		±50	mA
I _{CC} or I _{GND}	DC Supply Current per Supply Pin or Ground Pin	±100	mA	
T _{STG}	Storage Temperature Range		-65 to +150	_°C
ΤL	Lead Temperature, 1 mm from Case for 10 secs		260	°C
TJ	Junction Temperature Under Bias		+150	°C
θ_{JA}	Thermal Resistance (Note 2)	SC-88A SOT-553 SOT-953	377 324 254	°C/W
PD	Power Dissipation in Still Air	SC-88A SOT-553 SOT-953	Semi 332 386 491	mW
MSL	Moisture Sensitivity	DE O	Level 1	-
F _R	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	-
V_{ESD}	ESD Withstand Voltage (Note 3)	Human Body Model Charged Device Model	2000 1000	V
I _{Latchup}	Latchup Performance (Note 4)	A CH	±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Applicable to devices with outputs that may be tri-stated.

 Applicable to devices with outputs that may be tri-stated.
Measured with minimum pad spacing on an FR4 board, using 10mm-by-1inch, 2 ounce copper trace no air flow per JESD51-7.
HBM tested to ANSI/ESDA/JEDEC JS-001-2017. CDM tested to EIA/JESD22-C101-F. JEDEC recommends that ESD qualification to EIA/JESD22-A115-A (Machine Model) be discontinued per JEDEC/JEP172A.
Tested to EIA/JESD78 Class II. cut7.CL rediscontinuer REPRESE

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RECOMMENDED OPERATING CONDITIONS

Symbol	Character	Min	Max	Unit	
V _{CC}	Positive DC Supply Voltage		1.65	5.5	V
V _{IN}	DC Input Voltage		0	5.5	V
V _{OUT}	DC Output Voltage	Active-Mode (High or Low State) Tri-State Mode (Note 1) Power-Down Mode (V _{CC} = 0 V)	0 0 0	V _{CC} 5.5 5.5	V
	DC Output Voltage	(NL17SZ07P5T5G-L22088 Only)	0	V _{CC}	
T _A	Operating Temperature Range		-55	+125	°C
t _r , t _f	Input Rise and Fall Time	$V_{CC} = 3.0 V \text{ to } 3.6 V$ $V_{CC} = 4.5 V \text{ to } 5.5 V$	0 0	100 20	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

DC ELE	C ELECTRICAL CHARACTERISTICS							A	•
			Vcc	Т	_A = 25°	С	–55°C ≤ T	A ≤ 125°C	
Symbol	Parameter	Condition	(V)	Min	Тур	Max	Min	Max	Units
VIH	High-Level Input		1.65 to 1.95	0.75 x V _{CC}	-	-	0.75 x V _{CC}	-	V
	Voltage		2.3 to 5.5	$0.70 \times V_{CC}$	-	- 1	0.70 x V _{CC}	-	
V _{IL}	Low-Level Input		1.65 to 1.95		-	0.25 x V _{CC}	-	$0.25 \times V_{CC}$	V
	Voltage		2.3 to 5.5	-		0.30 x V _{CC}		0.30 x V _{CC}	
V _{OL}	Low-Level Output Voltage		1.65 to 5.5 1.65 2.3 2.7 3.0 3.0 4.5	MENC	0.08 0.2 0.22 0.28 0.38 0.38	0.1 0.24 0.3 0.4 0.4 0.55 0.55	AT	0.1 0.24 0.3 0.4 0.4 0.55 0.55	V
I _{IN}	Input Leakage Cur- rent	V _{IN} = 5.5 V or GND	1.65 to 5.5	IE-FO	-	±0.1	-	±1.0	μΑ
I _{OZ}	3-State Output Leakage Current	V _{OUT} = 0 V to 5.5 V	1.65 to 5.5	- 1	-	±0.5	-	±5.0	μA
I _{OFF}	Power Off Leakage Current	V _{IN} = 5.5 V or V _{OUT} = 5.5 V	0	-	_	1.0	-	10	μA
	Power Off Leakage Current (NL17SZ07P5T5G- L22088 Only)	V _{IN} = 5.5 V	0	-	-	1.0	-	10	μΑ
I _{CC}	Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND	5.5	-	-	1.0	-	10	μA
I _{CCT}	Quiescent Supply Current	V _{IN} = 3.0 V	3.6	-	-	10	-	100	μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

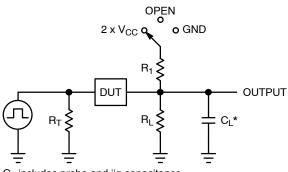
AC ELECTRICAL CHARACTERISTICS

			V _{CC}	T,	T _A = 25°C		–55°C ≤ T _A ≤ 125°C		
Symbol	Parameter	Condition	(V)	Min	Тур	Max	Min	Max	Units
t _{PZL}	Propagation Delay, A to Y		1.65 to 1.95	-	6.0	9.0	-	9.5	ns
	(Figures 3 and 4)		2.3 to 2.7	-	3.6	6.1	-	6.5	
			3.0 to 3.6	-	2.7	5.6	-	6.0	
			4.5 to 5.5	-	2.1	4.4	-	4.8	
t _{PLZ}	Propagation Delay, A to Y	Y	1.65 to 1.95	-	4.0	9.0	-	9.5	ns
	(Figures 3 and 4)		2.3 to 2.7	-	2.8	6.1	-	6.5	
			3.0 to 3.6	-	2.5	5.6	-	6.0	
			4.5 to 5.5		2.2	4.4	-	4.8	1

CAPACITIVE CHARACTERISTICS

CAPACIT	IVE CHARACTERISTICS		42	
Symbol	Parameter	Condition	Typical	Units
C _{IN}	Input Capacitance	V_{CC} = 5.5 V, V_{IN} = 0 V or V_{CC}	2.5	pF
C _{OUT}	Output Capacitance	V_{CC} = 5.5 V, V_{IN} = 0 V or V_{CC}	4.0	pF
C _{PD}	Power Dissipation Capacitance (Note 5)	10 MHz, V_{CC} = 5.5 V, V_{IN} = 0 V or V_{CC}	4.0	pF

 $C_{PD} \text{ is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: <math display="block">|_{OC(OPR)} = C_{PD} \bullet V_{CC} \bullet f_{in} + |_{CC} \bullet C_{PD} \text{ is used to determine the no-load dynamic power consumption; } P_D = C_{PD} \bullet V_{CC}^2 \bullet f_{in} + |_{CC} \bullet V_{CC}$ 5. C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

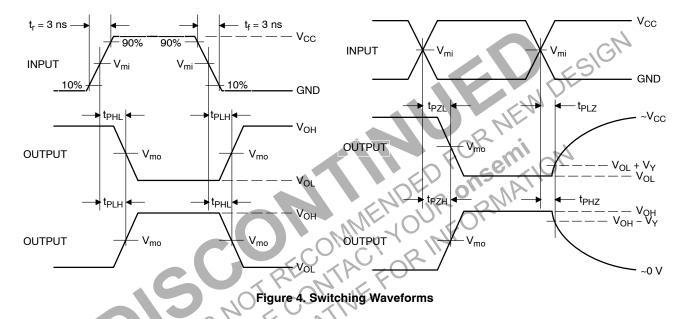


t _{PLH} / t _{PHL} Open See AC Characteristics Table t _{PLZ} / t _{PZL} 2 x V _{CC} 50 500 500 t _{PHZ} / t _{PZH} GND 50 500 500	Test	Switch Position	C _L , pF	R_{L}, Ω	R ₁ , Ω			
	t _{PLH} / t _{PHL}	Open	See AC Characteristics Table					
t _{PHZ} / t _{PZH} GND 50 500 500	t _{PLZ} / t _{PZL}	$2 \times V_{CC}$	50	500	500			
	t _{PHZ} / t _{PZH}	GND	50	500	500			

X = Don't Care

 C_L includes probe and jig capacitance R_T is Z_{OUT} of pulse generator (typically 50 $\Omega)$ f = 1 MHz

Figure 3. Test Circuit



	NCENERGE	V _m	o, V	
V _{CC} , V	V _{mi} , V	t _{PLH} , t _{PHL}	t _{PZL} , t _{PLZ} , t _{PZH} , t _{PHZ}	V _Y , V
1.65 to 1.95	V _{CC} /2	V _{CC} /2	V _{CC} /2	0.15
2.3 to 2.7	V _{CC} /2	V _{CC} /2	V _{CC} /2	0.15
3.0 to 3.6	V _{CC} /2	V _{CC} /2	V _{CC} /2	0.3
4.5 to 5.5	V _{CC} /2	V _{CC} /2	V _{CC} /2	0.3

NLV17SZ07

DEVICE ORDERING INFORMATION

Device	Packages	Specific Device Code	Pin 1 Orientation (See below)	Shipping [†]
NLV17SZ07DFT2G*	SC-88A	L7	Q4	3000 / Tape & Reel
NL17SZ07DFT2G-F22038	SC-88A	L7	Q4	3000 / Tape & Reel
NL17SZ07XV5T2G-L22087	SOT-553	L7	Q4	4000 / Tape & Reel
NL17SZ07P5T5G-L22088	SOT-953	D (Rotated 180° CW)	Q2	8000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

Pin 1 Orientation in Tape and Reel EW DESIGN Direction of Feed 0 Ο Ο WENSIONS F. OT ALTON WENSIONS F. OT ALTON OF ALTON ANTENOUR OR MATTON OF ALTON ANTENOUR OF ALTON ANTENOUR OF ALTON OF ALTON ANTENOUS ANTENOUR OF ALTON OF ALTON ANTENOUS AN

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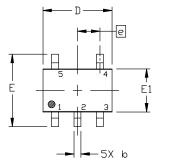
SC-88A (SC-70-5/SOT-353) CASE 419A-02 **ISSUE M**

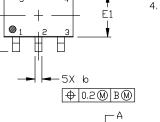
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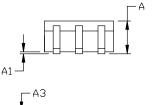
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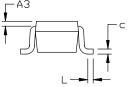
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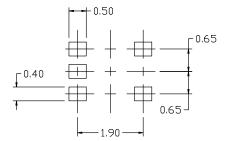
DATE 11 APR 2023











RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

DIM	MILLIMETERS					
MIU	MIN.	NDM.	MAX.			
A	0.80	0.95	1.10			
A1			0.10			
A3		0.20 REF	-			
b	0.10	0.20	0.30			
С	0.10		0.25			
D	1.80	2.00	5'50			
E	2.00	2.10	5'50			
E1	1.15	1.25	1.35			
e	0.65 BSC					
L	0.10	0.15	0.30			

DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH,

PROTRUSIONS, OR GATE BURRS.MOLD FLASH, PROTRUSIONS,

OR GATE BURRS SHALL NOT EXCEED 0.1016MM PER SIDE.

CONTROLLING DIMENSION: MILLIMETERS 419A-01 DBSOLETE, NEW STANDARD 419A-02

GENERIC MARKING





*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

XXX = Specific Device Code

Μ = Date Code = Pb-Free Package

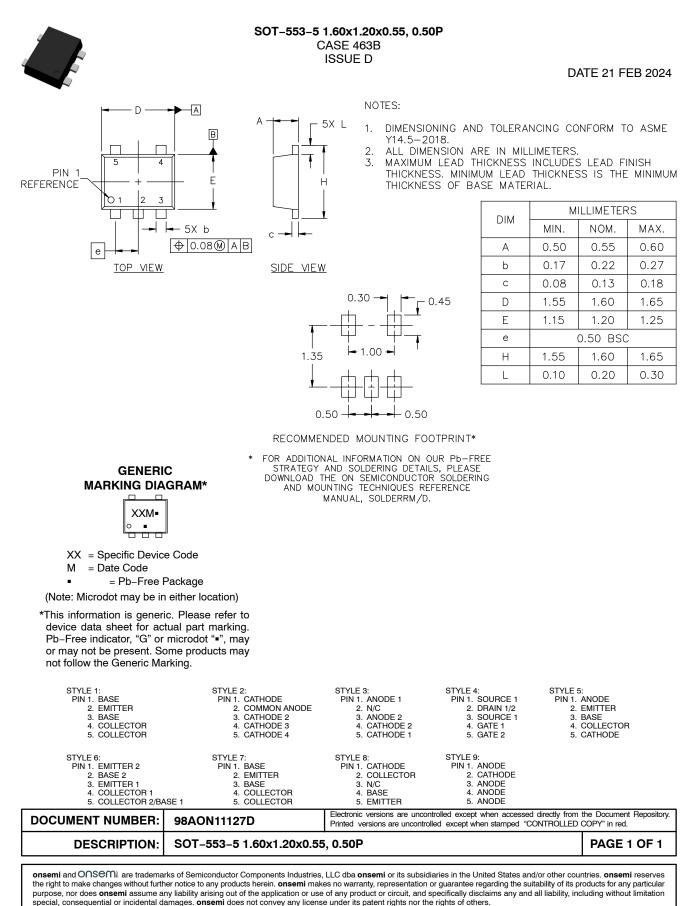
(Note: Microdot may be in either location)

STYLE 1: PIN 1. BASE 2. EMITTER 3. BASE 4. COLLECTOR 5. COLLECTOR	STYLE 2: PIN 1. ANODE 2. EMITTER 3. BASE 4. COLLECTOR 5. CATHODE	STYLE 3: PIN 1. ANODE 1 2. N/C 3. ANODE 2 4. CATHODE 2 5. CATHODE 1	STYLE 4: PIN 1. SOURCE 1 2. DRAIN 1/2 3. SOURCE 1 4. GATE 1 5. GATE 2	STYLE 5: PIN 1. CATHODE 2. COMMON ANOD 3. CATHODE 2 4. CATHODE 3 5. CATHODE 4	E
STYLE 6: PIN 1. EMITTER 2 2. BASE 2 3. EMITTER 1 4. COLLECTOR 5. COLLECTOR 2/BASE	STYLE 7: PIN 1. BASE 2. EMITTER 3. BASE 4. COLLECTOR 1 5. COLLECTOR	STYLE 8: PIN 1. CATHODE 2. COLLECTOR 3. N/C 4. BASE 5. EMITTER	STYLE 9: PIN 1. ANODE 2. CATHODE 3. ANODE 4. ANODE 5. ANODE	Note: Please refer to style callout. If style to out in the datasheet r datasheet pinout or p	ype is not called efer to the device
DOCUMENT NUMBER:	98ASB42984B			ot when accessed directly from when stamped "CONTROLLED (
DESCRIPTION:	SC-88A (SC-70-	PAGE 1 OF 1			

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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



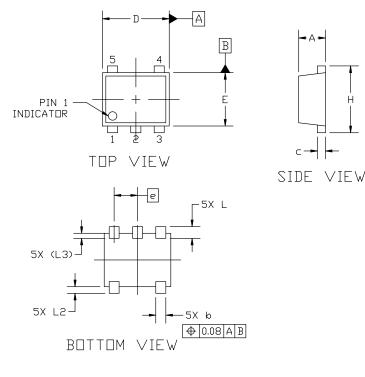
SOT-953 1.00x0.80x0.37, 0.35P CASE 527AE ISSUE F

DATE 17 JAN 2024

DUSEM

NDTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS DF THE BASE MATERIAL.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.



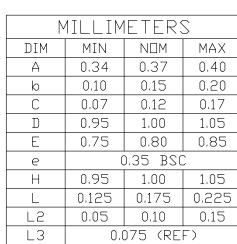
GENERIC MARKING DIAGRAM*

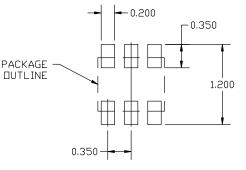


- X = Specific Device Code M = Month Code
- *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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RECOMMENDED MOUNTING FOOTPRINT

*For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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